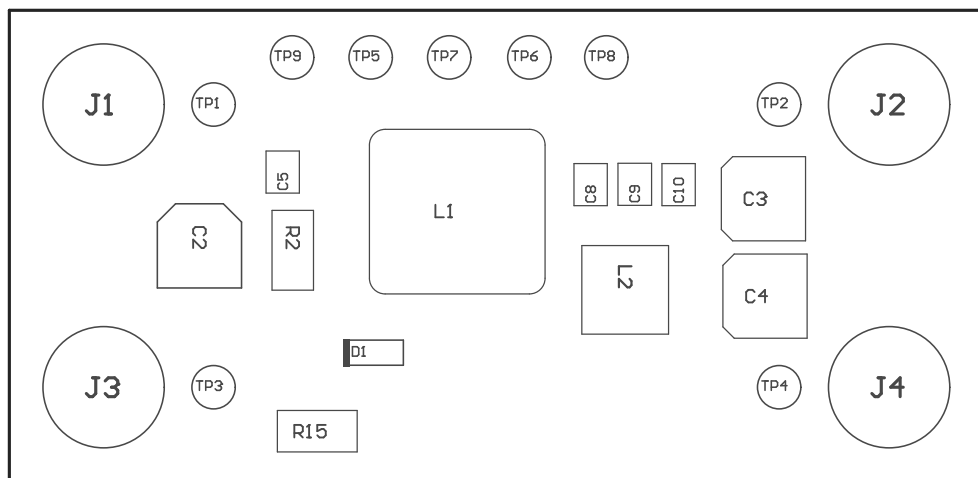


Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

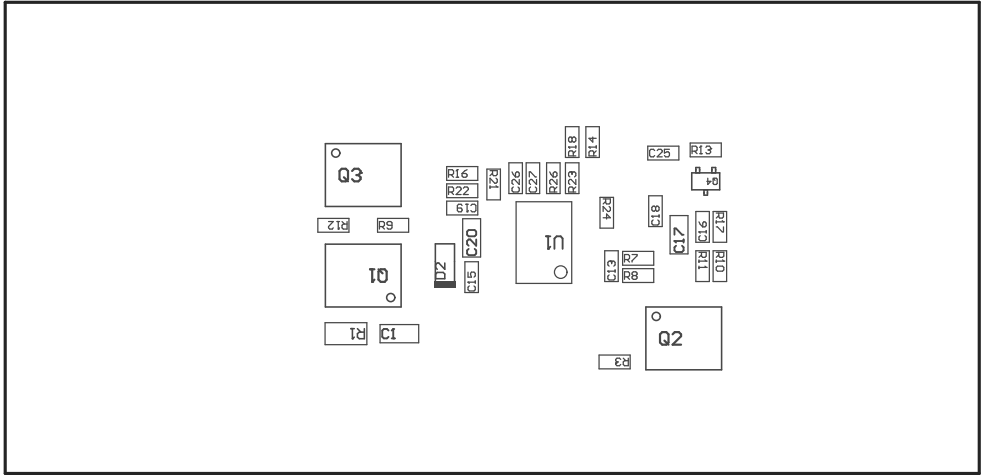
Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11422	REV: A	SUN REV: Not In VersionControl
	TID #: PMP11422		
PLOT NAME = Top Assembly Drawing	GENERATED : 10/15/2015 2:38:57 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11422	REV: A	SUN REV: Not In VersionControl
	TID #: PMP11422		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/15/2015 2:38:58 PM		TEXAS INSTRUMENTS

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